



IMFEDK 2024

The 2024 International Meeting for Future of Electron Devices, Kansai

Paper submission deadline: Sept. 7

[Presentation]**[Oral]**

- Invited - Onsite or Online
- Contributed - Onsite

[Poster]

- Contributed - Onsite

[Attendance]**[Oral]**

- Onsite or Online

[Poster]

- Onsite

[Registration fee]

[Presenters (excluding Invited)]

¥5,000

[Others]

Free !!

Keynote speeches & Invited talks

To be determined

Important dates:

(1) **Paper submission deadline: Sept. 7**

(2) **Participation registration deadline: Nov. 14**

Registration information:

Registration information will be shown on the Web site.

<http://www.ieee-jp.org/section/kansai/chapter/eds/imfedk/>

Travel information: Jojukan : <https://www.ryukoku.ac.jp/english2/about/access/fukakusa.html>

Nearest stations : Keihan Ryukokudai-mae-fukakusa or Subway Kuinabashi,

(1) Attendees will find many hotels around JR Kyoto stations.

(2) Foreign attendees coming from Kansai Int. Airport (KIX) are recommended to use limited express "Haruka" from KIX to JR Kyoto station due to its direct access (~90 min.).

IMFEDK Committee

General chair: J. T. Asubar (Univ. Fukui), *Conference chair:* M. Kimura (Ryukoku Univ.)

Program chair: Y. Kamakura (OIT), *Local arrangement:* Y. Omura (ACA)

Vice Chair: H. Ishida (Panasonic), K. Hayashi (Kobe Steel)

Secretary: T. Matsuda (Kindai), *Treasurer:* Y. Oku (Rohm)

Committee: K. Nakahara (Rohm), M. Furuhashi (Mitsubishi Electric), S. Sato (Kansai Univ.), T. Fukuda (Sekisui Chemical), S. Koba (Kobe City College Tech.), Y. Uraoka (NAIST), H. Nishinaka (KIT), Y. Ando (Ricoh), N. Shigekawa (Osaka Metropolitan Univ.), N. Ueda (Nisshinbo Micro Devices), M. Kuzuhara (Kwansei Gakuin Univ.), M. Noda (KIT), Y. Murase (Murata Manufacturing), A. Hiroki (KIT), T. Maemoto (OIT), S. Soma (Kobe Univ.), M. Moniwa (TUT), N. Matsuo (Univ. Hyogo), T. Kato (Murata Manufacturing), T. Seki (Omron), E. Kanda (Kyocera), K. Okada (Panasonic TowerJazz), S. Murakami (ORIST), Y. Murayama (Nisshinbo Micro Devices), K. Sakurano (Ricoh), M. Yoshimoto (KIT), S. Sasa (OIT), Y. Yaoi (Ishida), A. Fukui (Sharp), T. Kimoto (Kyoto Univ.), M. Ogawa (Kobe Univ.), M. Fujii (Kindai), S. Okura (Ritsumeikan Univ.), H. Watanabe (W.T.C.), M. Uenuma (NAIST), H. Umezawa (AIST), Y. Sato (Panasonic)

We will take all possible precautions, but we are not responsible for the leakage of information sent to us in the unlikely event.

Paper submission information

(<http://www.ieee-jp.org/section/kansai/chapter/eds/imfedk/>)

(1) **All papers** should be submitted along the guidelines at the Web site..

(2) **Keynote speeches and Invited talks**

Please follow the IEEE format provided by the committee.

Paper should not exceed **4 printed pages**. The paper of 1-page is regarded as Abstract and will not be published in Xplore, whereas that of more than 2-page is regarded as Proceeding and will be published in Xplore.

(3) **Oral presentation**

Anyone, including students, can submit a paper as an oral presentation.

Please follow the IEEE format provided by the committee.

Paper should not exceed **2 printed pages**. The paper will be published in Xplore. All submitted papers will be reviewed by the Committee, and low-quality paper(s) will be rejected.

(4) **Poster presentation**

Anyone, including students, can submit a paper as a poster presentation.

Please follow the IEEE format provided by the committee.

Paper should not exceed **2 printed pages**. The paper will not be published in Xplore. The papers are confidential within IMFEDK and are not to be brought out. All submitted papers will be reviewed by the Committee, and low-quality paper(s) will be rejected.

(5) **Awards** will be presented to excellent papers by the committee.

TECHNICAL SPONSOR

To be determined

SOCIETY®